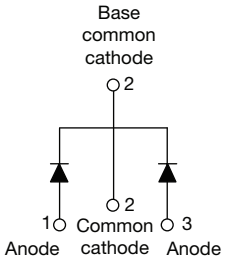
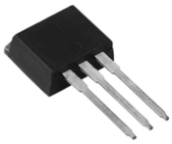
Schottky Rectifier, 2 x 10 A

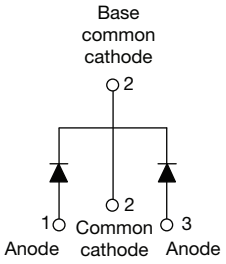
VS-MBRB20...CTGPbF



D^2PAK

VS-MBR20...CTG-1PbF





TO-262

FEATURES

- 150 °C T_J operation
- Center tap D^2PAK and TO-262 packages
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified

Pb e3 RoHS COMPLIANT HALOGEN FREE

DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

PRODUCT SUMMARY	
$I_{F(AV)}$	2 x 10 A
V_R	80 V to 100 V

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUES	UNITS
I_{FRM}	T_C = 133 °C (per leg)	20	A
V_{RRM}		80 to 100	V
I_{FSM}	t_p = 5 µs sine	850	A
V_F	10 Apk, T_J = 125 °C	0.70	V
T_J	Range	- 65 to 150	°C

VOLTAGE RATINGS					
PARAMETER	SYMBOL	VS-MBRB2080CTGPbF VS-MBR2080CTG-1PbF	VS-MBRB2090CTGPbF VS-MBR2090CTG-1PbF	VS-MBRB20100CTGPbF VS-MBR20100CTG-1PbF	UNITS
Maximum DC reverse voltage	V_R	80	90	100	V
Maximum working peak reverse voltage	V_{RWM}				

ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	per leg	$I_{F(AV)}$	T_C = 133 °C, rated V_R		10	A
	per device				20	
Peak repetitive forward current per leg		I_{FRM}	Rated V_R, square wave, 20 kHz T_C = 133 °C		20	
Non-repetitive peak surge current		I_{FSM}	5 µs sine or 3 µs rect. pulse	Following any rated load condition and with rated V_{RRM} applied	850	
			Surge applied at rated load conditions half wave, single phase, 60 Hz		150	
Peak repetitive reverse surge current		I_{RRM}	2.0 µs, 1.0 kHz		0.5	
Non-repetitive avalanche energy per leg		E_{AS}	T_J = 25 °C, I_{AS} = 2 A, L = 12 mH		24	mJ

ELECTRICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	V_{FM} (1)	10 A	T_J = 25 °C	0.80	V
		20 A		0.95	
		10 A	T_J = 125 °C	0.70	
		20 A		0.85	
Maximum instantaneous reverse current	I_{RM} (1)	T_J = 25 °C	V_R = Rated V_R	0.10	mA
		T_J = 125 °C		6	
Threshold voltage	$V_{F(TO)}$	T_J = T_J maximum		0.433	V
Forward slope resistance	r_t			15.8	mΩ
Maximum junction capacitance	C_T	V_R = 5 V_{DC} (test signal range 100 kHz to 1 MHz), 25 °C		400	pF
Typical series inductance	L_S	Measured from top of terminal to mounting plane		8.0	nH
Maximum voltage rate of change	dV/dt	Rated V_R		10 000	V/µs

Note

(1) Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS

PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction temperature range		T_J		- 65 to 150	°C
Maximum storage temperature range		T_{Stg}		- 65 to 175	
Maximum thermal resistance, junction to case per leg		R_{thJC}	DC operation	2.0	°C/W
Maximum thermal resistance junction to ambient		R_{thJA}		50	
Approximate weight				2	g
				0.07	oz.
Mounting torque	minimum		Non-lubricated threads	6 (5)	kgf · cm (lbf · in)
	maximum			12 (10)	
Marking device			Case style D²PAK	MBRB2080CTG	
				MBRB2090CTG	
				MBRB20100CTG	
			Case style TO-262	MBR2080CTG-1	
				MBR2090CTG-1	
				MBR20100CTG-1	

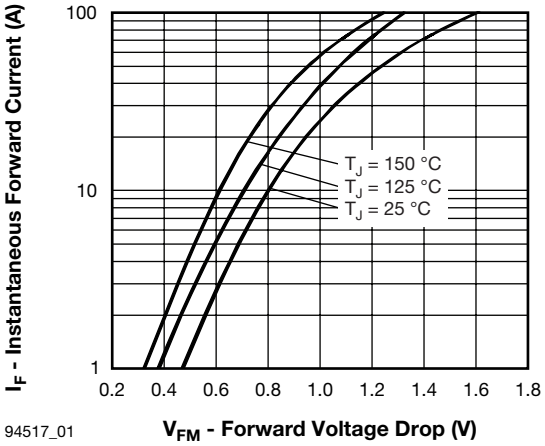


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

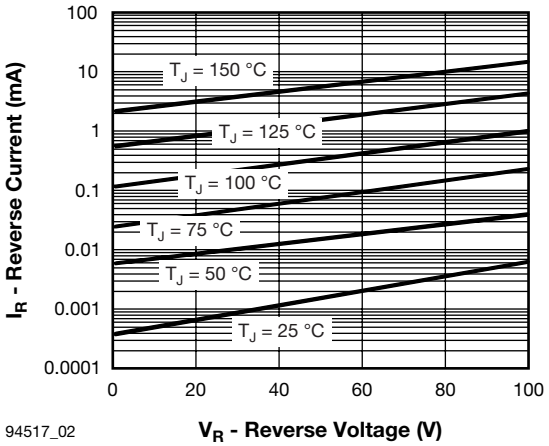


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

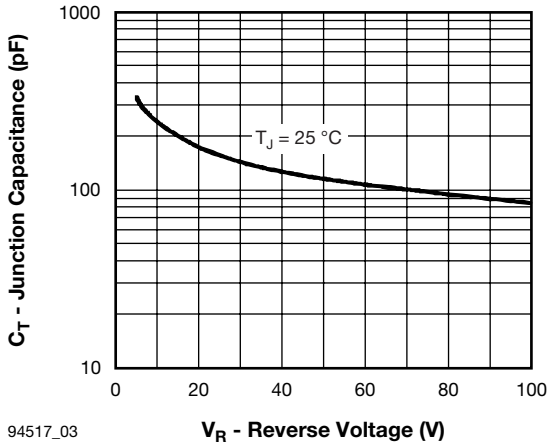


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

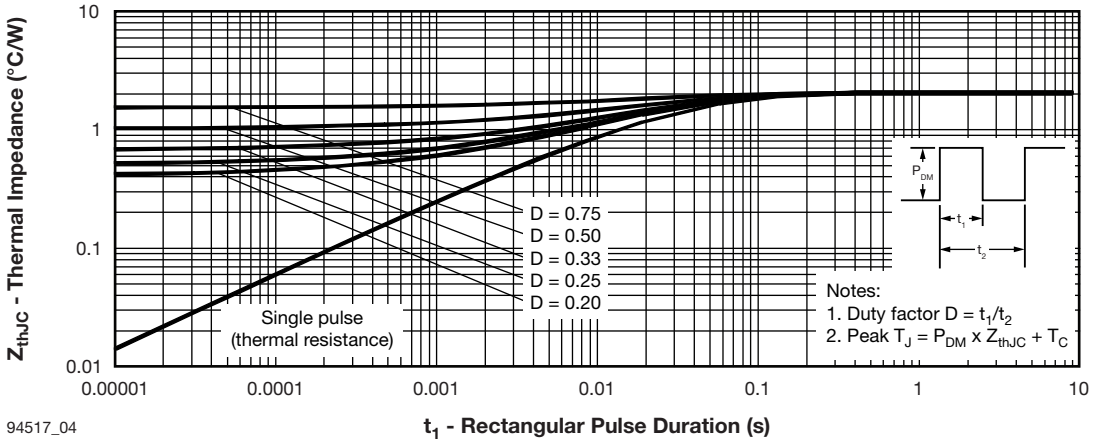


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

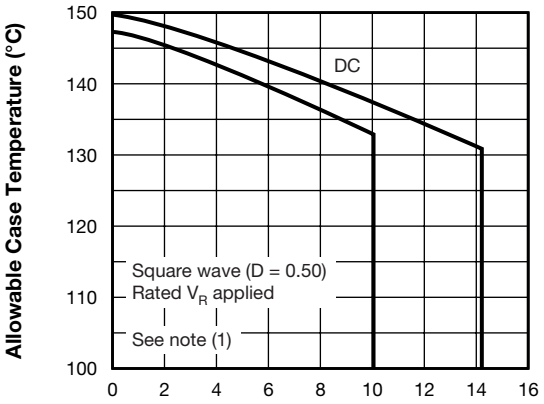


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

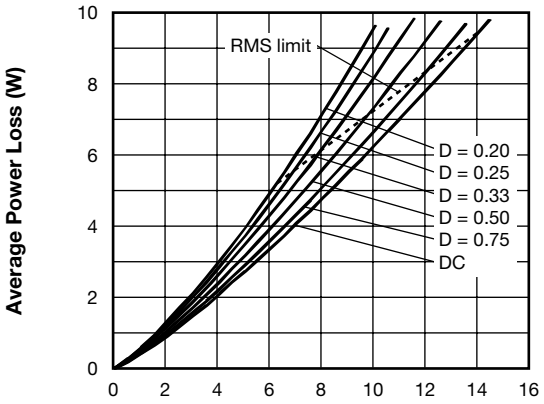


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

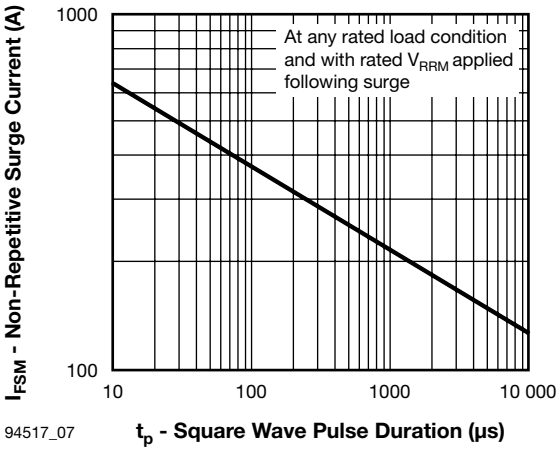


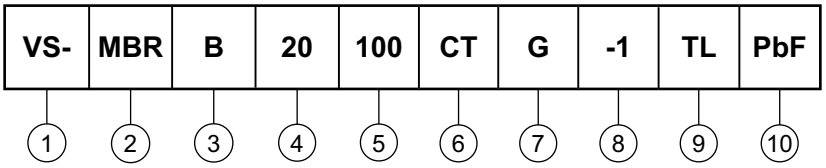
Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;
Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at ($I_{F(AV)}$/D) (see fig. 6);
Pd_{REV} = Inverse power loss = $V_{R1} \times I_R$ (1 - D); I_R at V_{R1} = Rated V_R

ORDERING INFORMATION TABLE

Device code



1 - HPP product suffix

2 - Essential part number

3 - • B = D^2PAK
• None = TO-262

4 - Current rating (20 = 20 A)

5 - Voltage ratings — 80 = 80 V, 90 = 90 V, 100 = 100 V

6 - CT = Essential part number

7 - G = Schottky generation

8 - • None = D^2PAK
• -1 = TO-262

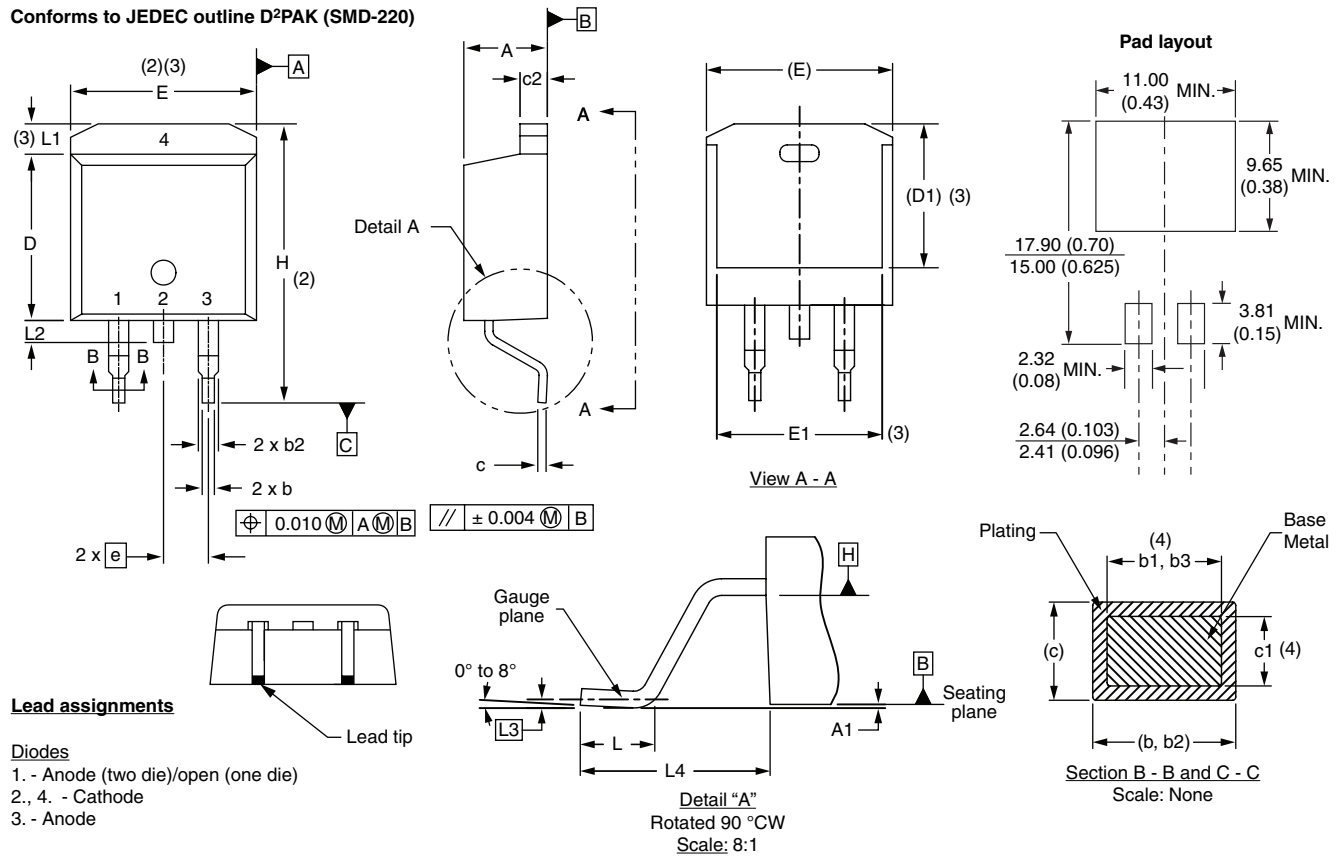
9 - • None = Tube (50 pieces)
• TL = Tape and reel (left oriented - for D^2PAK only)
• TR = Tape and reel (right oriented - for D^2PAK only)

10 - • PbF = Lead (Pb)-free (for D^2PAK tube)
• P = Lead (Pb)-free (for D^2PAK TL/TR, and TO-262)

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95014
Part marking information	www.vishay.com/doc?95008
Packaging information	www.vishay.com/doc?95032

D²PAK, TO-262

DIMENSIONS FOR D²PAK in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
H	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010 BSC		
L4	4.78	5.28	0.188	0.208	

Notes

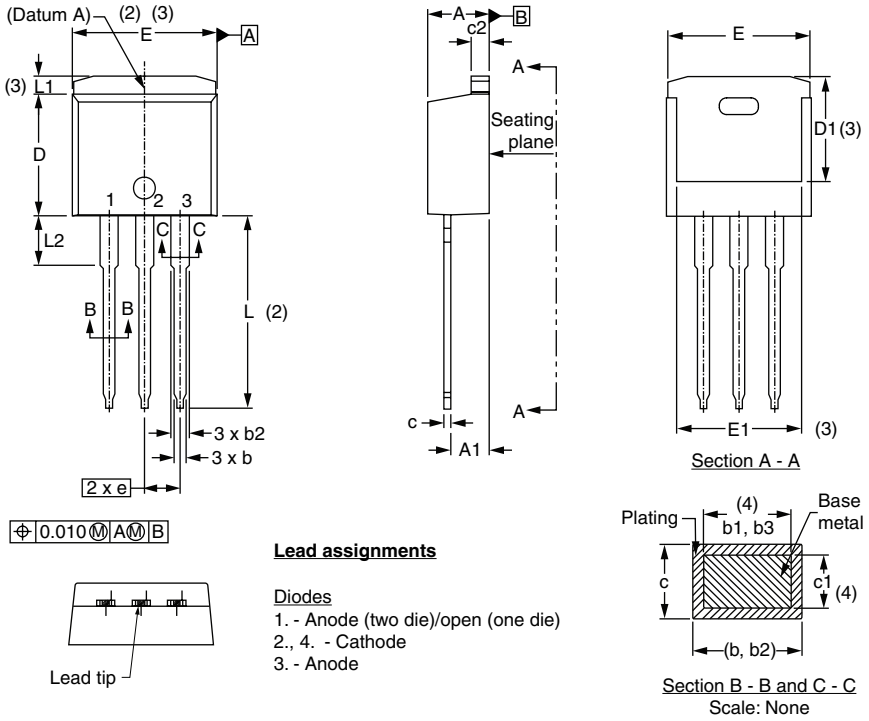
(1) Dimensioning and tolerancing per ASME Y14.5 M-1994
(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
(3) Thermal pad contour optional within dimension E, L1, D1 and E1
(4) Dimension b1 and c1 apply to base metal only
(5) Datum A and B to be determined at datum plane H
(6) Controlling dimension: inch
(7) Outline conforms to JEDEC outline TO-263AB

Outline Dimensions

Vishay High Power Products D²PAK, TO-262

DIMENSIONS FOR TO-262 in millimeters and inches

Modified JEDEC outline TO-262



Lead assignments

Diodes
1. - Anode (two die)/open (one die)
2., 4. - Cathode
3. - Anode

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

Notes

(1) Dimensioning and tolerancing as per ASME Y14.5M-1994
(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
(3) Thermal pad contour optional within dimension E, L1, D1 and E1
(4) Dimension b1 and c1 apply to base metal only
(5) Controlling dimension: inches
(6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline

For technical questions concerning discrete products, contact: diodes-tech@vishay.com
For technical questions concerning module products, contact: ind-modules@vishay.com

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